



Product Change Notice

PCN Number: 15-0520-01
Issue Date: 27-AUGUST-2015

Exar Corporation

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PRODUCTS AFFECTED:

SP3070EMN-L	SP3070EMN-L/TR
SP3071EMN-L	SP3071EMN-L/TR
SP3072EMN-L	SP3072EMN-L/TR
SP3073EMN-L	SP3073EMN-L/TR
SP3074EMN-L	SP3074EMN-L/TR
SP3075EMN-L	SP3075EMN-L/TR
SP3076EMN-L	SP3076EMN-L/TR
SP3077EMN-L	SP3077EMN-L/TR
SP3078EMN-L	SP3078EMN-L/TR

CHANGE CATEGORY:

- | | | |
|---|---|---|
| ☐ Material | ☒ Process | ☐ Package |
| ☐ Design | ☐ Datasheet | ☐ Packing/Shipping |
| ☒ Other: Alternate Foundry and Assembly/Test Site | | |

DESCRIPTION OF CHANGE:

Qualification of 0.25um CMOS process at TSMC.

Qualification of alternate assembly sites, Carsem (for 8 and 14L nSOIC) and ASE Chung-Li (for 8L nSOIC).

IMPACT OF CHANGE:

No change to product form, fit or function.

TARGET IMPLEMENTATION DATE: 27-NOVEMBER-2015

Please contact customer support (customersupport@exar.com) for sample date availability or qualification data

PROPRIETARY INFORMATION

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